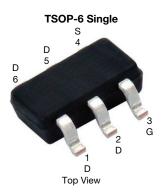


Vishay Siliconix

N-Channel 150 V (D-S) MOSFET



Marking code: BS

PRODUCT SUMMARY						
V _{DS} (V)	150					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 10 \text{ V}$	0.380					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$	0.432					
Q _g typ. (nC)	1.65					
I _D (A) ^d	2.2					
Configuration	Single					

FEATURES

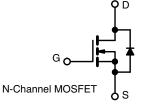
- ThunderFET® power MOSFET
- 100 % R_g tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

- DC/DC converters
- · Boost converters
- · LED backlighting
- PD switch
- · Load switch



ORDERING INFORMATION	
Package	TSOP-6
Lead (Pb)-free and halogen-free	Si3440ADV-T1-GE3

PARAMETER Drain-source voltage Gate-source voltage		SYMBOL	LIMIT	UNIT
		V _{DS}	150 ± 20	
		V _{GS}		
	T _C = 25 °C		2.2	
O-ation and during a support (T. 150 °C)	T _C = 70 °C		1.7	
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	l _D	1.6 ^{a, b}	
	T _A = 70 °C		1.3 ^{a, b}	•
Pulsed drain current (t = 100 μs)		I _{DM}	4	Α
<u> </u>	T _C = 25 °C		3	
Continuous source-drain diode current	T _A = 25 °C	I _S	1.7 ^{a, b}	
Single pulse avalanche current	1 0.1 ml l	I _{AS}	3	
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	0.45	mJ
	T _C = 25 °C		3.6	
Maximum power dissipation	T _C = 70 °C		2.3	147
	T _A = 25 °C	P _D	2 ^{a, b}	W
	T _A = 70 °C		1.3 ^{a, b}	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient a, c	t ≤ 10 s	R _{thJA}	50	62.5	°C/W	
Maximum junction-to-foot (drain)	Steady state	R_{thJF}	28	35	C/VV	

Notes

- a. Surface mounted on 1" x 1" FR4 board
- b. t = 10 s
- c. Maximum under steady state conditions is 110 °C/W
- d. $T_C = 25$ °C



Vishay Siliconix

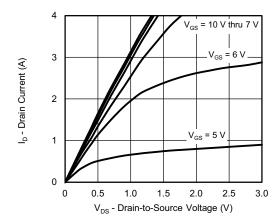
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static				•		
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	150	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	135	-	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	1	-5.6	-	mV/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2	-	4	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Zava gata valtaga duain avuvant	I _{DSS}	V _{DS} = 150 V, V _{GS} = 0 V	-	-	1	μΑ
Zero gate voltage drain current		V _{DS} = 150 V, V _{GS} = 0 V, T _J = 70 °C	-	-	10	
On-state drain current ^a	I _{D(on)}	$V_{DS} \le 10 \text{ V}, V_{GS} = 10 \text{ V}$	4	-	-	Α
Delta de la contrata del contrata de la contrata del contrata de la contrata del contrata de la contrata de la contrata del contrata de la contrata del contrata de la contrata del contr		V _{GS} = 10 V, I _D = 1.5 A	ī	0.316	0.380	1 -
Drain-source on-state resistance a	R _{DS(on)}	V _{GS} = 7.5 V, I _D = 1 A	-	0.345	0.432	Ω
Forward transconductance a	9 _{fs}	$V_{DS} = 50 \text{ V}, I_D = 1.5 \text{ A}$	-	2.4	-	S
Dynamic ^b						
Input capacitance	C _{iss}		-	80	-	pF
Output capacitance	C _{oss}	$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	26	-	
Reverse transfer capacitance	C _{rss}		ī	3	-	
Total gate charge	Qg	V _{DS} = 75 V, V _{GS} = 10 V, I _D = 0.5 A	ī	2	4	nC
			-	1.65	3	
Gate-source charge	Q _{gs}	$V_{DS} = 75 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 0.5 \text{ A}$	ī	0.5	-	
Gate-drain charge	Q _{gd}		1	0.7	-	
Gate resistance	R_g	f = 1 MHz	0.7	3.5	7	Ω
Turn-on delay time	t _{d(on)}		ī	8	16	
Rise time	t _r	$V_{DD} = 75 \text{ V}, R_L = 57.7 \Omega, I_D \cong 1.3 \text{ A},$	1	22	35	
Turn-off delay time	t _{d(off)}	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	9	18	1
Fall time	t _f		-	22	35]
Turn-on delay time	t _{d(on)}		-	10	20	ns -
Rise time	t _r	$V_{DD} = 75 \text{ V}, R_L = 57.7 \Omega, I_D \cong 1.3 \text{ A},$	-	25	40	
Turn-off delay time	t _{d(off)}	$V_{GEN} = 7.5 \text{ V}, R_g = 1 \Omega$	1	10	20	
Fall time	t _f		-	24	50	1
Drain-Source Body Diode Characteristi	cs					
Continuous source-drain diode current	Is	T _C = 25 °C	-	-	1.7	_
Pulse diode forward current	I _{SM}		-	-	4	A
Body diode voltage	V _{SD}	I _S = 1.3 A, V _{GS} = 0 V	-	0.85	1.2	V
Body diode reverse recovery time	t _{rr}		-	44	66	ns
Body diode reverse recovery charge	Q _{rr}		-	53	80	nC
Reverse recovery fall time	ta	$I_F = 1.3 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 ^{\circ}\text{C}$	-	27	-	
Reverse recovery rise time	t _b		-	17	-	ns

Notes

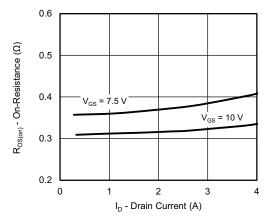
- a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

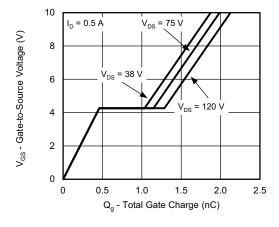




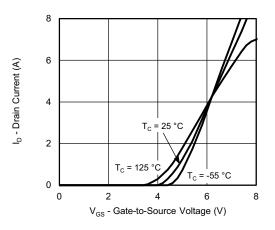
Output Characteristics



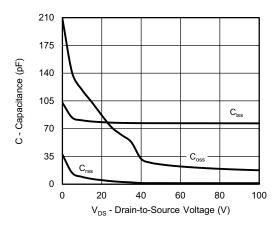
On-Resistance vs. Drain Current and Gate Voltage



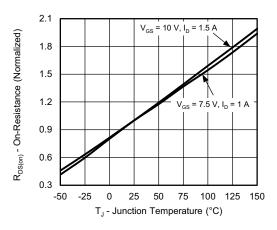
Gate Charge



Transfer Characteristics

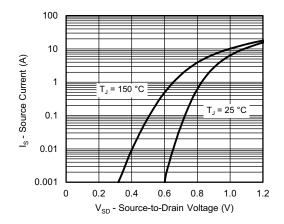


Capacitance

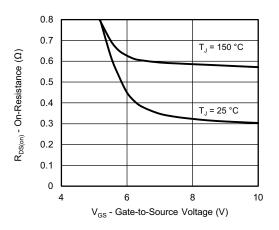


On-Resistance vs. Junction Temperature

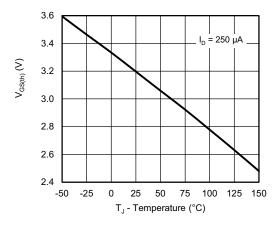




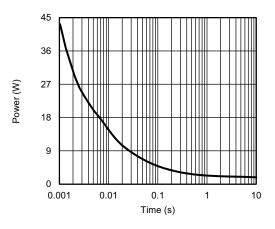
Source-Drain Diode Forward Voltage



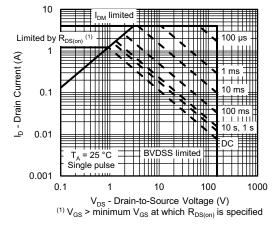
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage

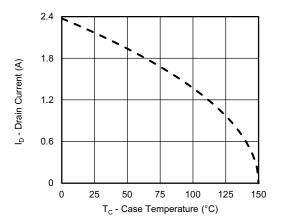


Single Pulse Power, Junction-to-Ambient

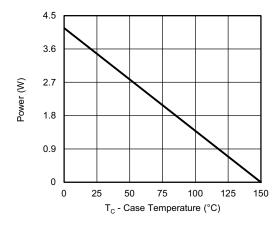


Safe Operating Area, Junction-to-Ambient

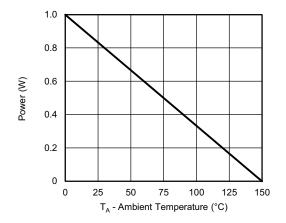




Current Derating a





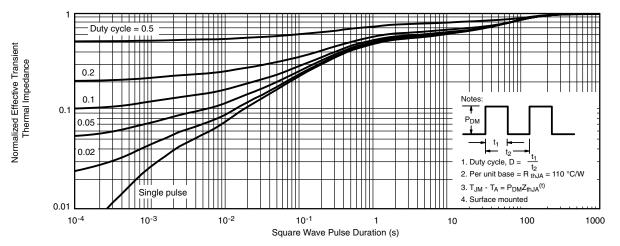


Power, Junction-to-Ambient

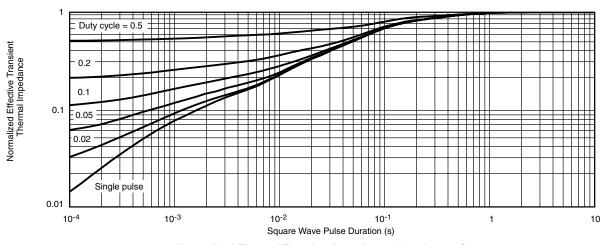
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

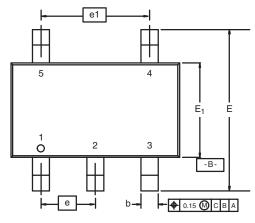
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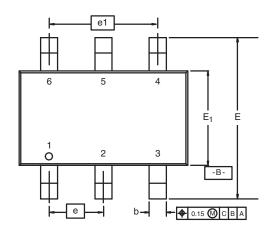




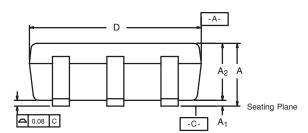
TSOP: 5/6-LEAD

JEDEC Part Number: MO-193C

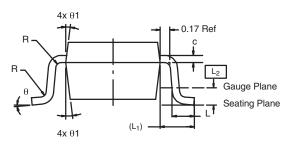




5-LEAD TSOP





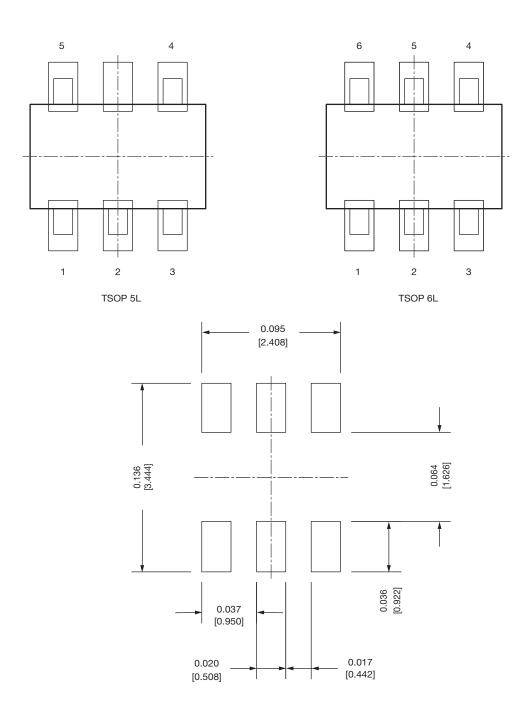


	MIL	LIMETER	RS	INCHES				
Dim	Min	Nom	Max	Min	Nom	Max		
Α	0.91	-	1.10	0.036	-	0.043		
A ₁	0.01	-	0.10	0.0004	-	0.004		
A ₂	0.90	-	1.00	0.035	0.038	0.039		
b	0.30	0.32	0.45	0.012	0.013	0.018		
С	0.10	0.15	0.20	0.004	0.006	0.008		
D	2.95	3.05	3.10	0.116	0.120	0.122		
E	2.70	2.85	2.98	0.106	0.112	0.117		
E ₁	1.55	1.65	1.70	0.061	0.065	0.067		
е		0.95 BSC		0.0374 BSC				
e ₁	1.80	1.90	2.00	0.071	0.075	0.079		
L	0.32	-	0.50	0.012	-	0.020		
L ₁		0.60 Ref			0.024 Ref			
L ₂	0.25 BSC			0.010 BSC				
R	0.10	-	-	0.004	-	-		
θ	0°	4°	8°	0°	4°	8°		
θ1	7° Nom			7° Nom				
ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540								

Document Number: 71200 18-Dec-06



Recommended Land Pattern For TSOP-5L / TSOP-6L



Note

• All dimensions are in inches (millimeter)

ECN: C22-0860-Rev. B, 24-Oct-2022 DWG: 3010



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